



## Insulation Related Specifications

|  |     |   |
|--|-----|---|
| Minimum creepage distance*                                   | Cr  | 4.0 mm                                      |
| Minimum clearance*   | Cl  | 4.0 mm                                      |
| Minimum insulation thickness                                 | ti  | 0.4 mm                                      |
| Comperative tracking index<br>(DIN IEC112 / VDE0303, part 1) | CTI | 175<br>(VDE0110 teil 1 / 01.89 group III a) |

\* in accordance with DIN VDE0110 teil 1 / 01.89, table 2, & 4)

1. If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value. If this is not permissible, the user shall take suitable measures.
2. This photocoupler is suitable for 'safe electrical isolation' only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.  
(Dieses koppelement ist für "sichere elektrische trennung" nur innerhalb der sicherheitsgrenzdaten geeignet. Die einhaltung der sicherheitsgrenzen muß durch schutzschaltungen sichergestellt sein.)

TLP181

VDE test sign: Marking on product  
for VDE0884  
: Marking on paking  
for VDE0884

V



Marking example:

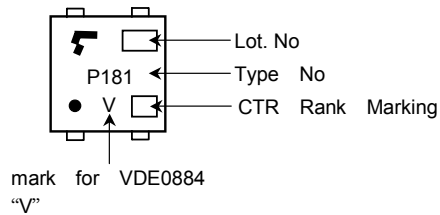


Figure 1 Partial discharge measurement procedure according to VDE0884  
Destructive test for qualification and sampling tests.

Method A  
(for type and sampling tests, destructive tests)

$t_1, t_2$  = 1 to 10s  
 $t_3, t_4$  = 1s  
 $t_p$  (Measuring time for partial discharge) = 50s  
 $t_b$  = 62s  
 $t_{ini}$  = 10s

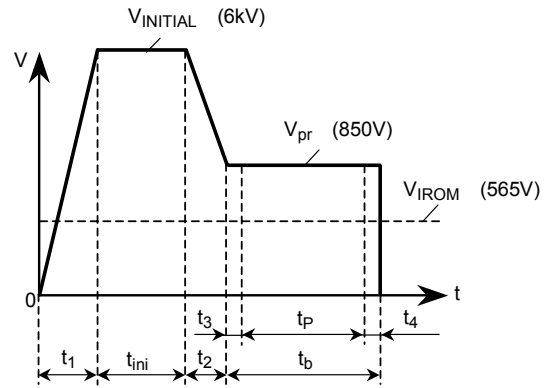


Figure 2 Partial discharge measurement procedure according to VDE0884  
Non-destructive test for 100% inspection.

Method B  
(for sample test, non-destructive test)

$t_3, t_4$  = 0.1s  
 $t_p$  (Measuring time for partial discharge) = 1s  
 $t_b$  = 1.2s

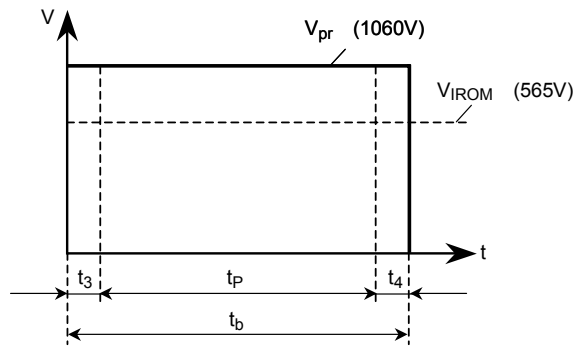
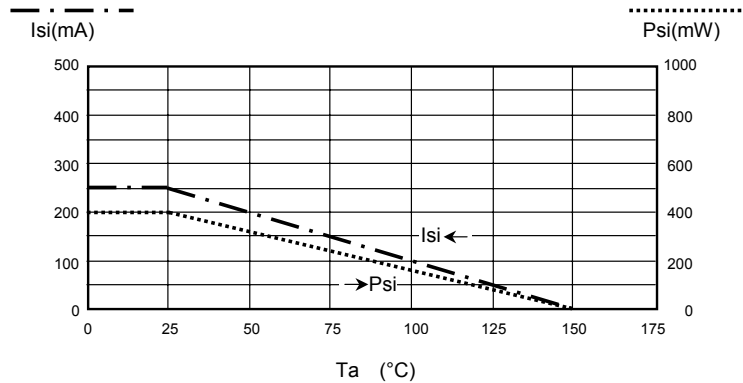


Figure 3 Dependency of maximum safety ratings on ambient temperature



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000707EBC

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